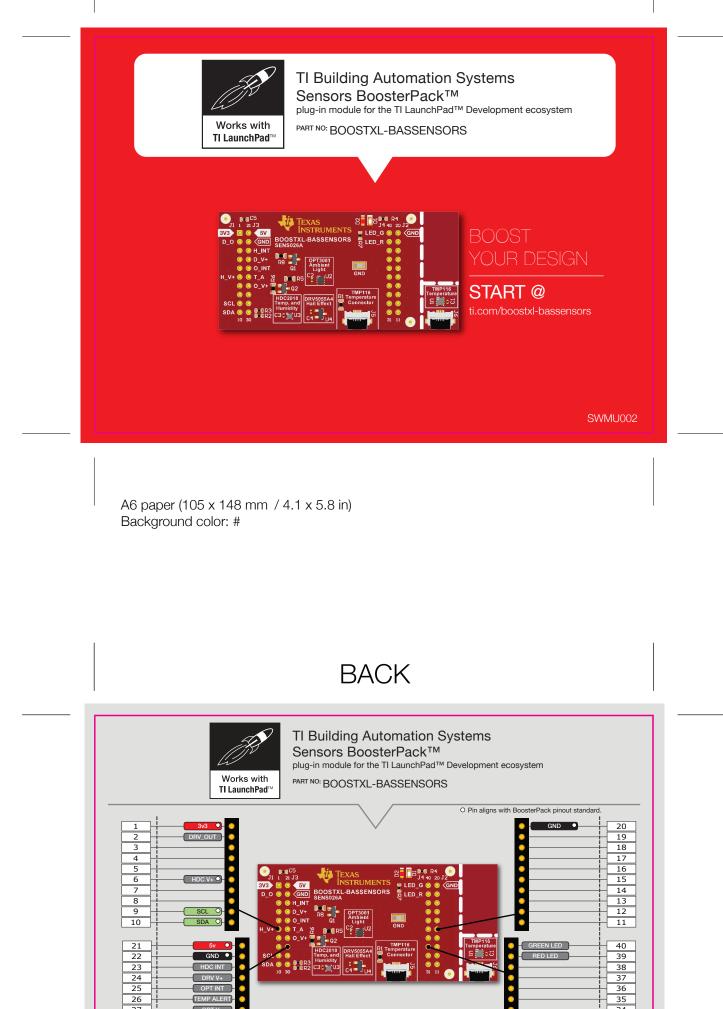
## **BOOSTXL-BASSENSORS QSG**

## FRONT





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A6 paper (105 x 148 mm / 4.1 x 5.8 in) Background color: #e0e0e0ff

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